# Henry Kou

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University of California, Los Angeles B.S. Electrical Engineering with breadth in Computer Science Class of 2021 Major GPA: 3.5/4.0

### **COURSE HIGHLIGHTS**

**CS-33** Computer Architecture

CS-110 OS Design

CS-32 Data Structures

**EE-115B** Advanced Circuit Analysis

EE-141 Feedback Systems

**EE-102** Systems and Signals

**EE-113** Digital Signal Processing

EE-101B RF Waves and Antennae

EE-121B Semiconductor Device Design

**EE-131A** Probability in EE

**EE-132A** Communication Systems

M-33B Differential Equations

M-33A Linear Algebra

#### **SKILLS**

#### **Analog Design:**

Altium, Switching Power Regulators **Embedded & Digital Systems:** STM32, MSP430, PSoC, Altera FPGAs, RPi, I2C, SPI

#### **SOFTWARE**

C, C++, Python, Linux, Simplis/PSPICE modeling, Eclipse IDE, Mbed, Git, MATLAB, VHDL, SystemVerilog, ROS

#### **EXPERIENCE**

# **Texas Instruments,** High Current Switching Regulators: **Analog Applications Engineer** (2021 - Current)

Applications Engineer for high current switching power regulator group specializing in design/test of multi-phase buck converter evaluation modules and closed loop feedback design with publications. Rotated through Power Design Services (PDS) on various custom power designs for Alpine, Tesla, Xilinx and Conti AG with over \$15M revenue tied.

# Research Assistant, CMU Robotics Institute (Fall 2019 - Current)

Funded on embedded systems applications and high level theory for modular, space-grade, and underwater robotics for publication under Professor Howie Choset and Project Scientist Lu Li.

### Raytheon Technologies: Digital Hardware Intern (Summer 2020)

Lab assistant and applications engineer for various digital hardware projects including power and thermal dissipation with aircraft-grade CLPDs and FPGA design.

## UCLA IEEE: Workshops Technical Lead (2019)

Responsible for leading lectures, designing projects, and hosting technical workshops for outreach with UCLA's IEEE Branch. Topics: PCB Design, SMD Soldering, SPI, I2C, UART, Bluetooth

## Naval Postgraduate School: Research Intern (Summer 2018)

Simulated and presented on the navigation of autonomous underwater vehicles using Simultaneous Localization and Mapping (SLAM) at the Center for Autonomous Vehicles

#### **PROJECTS GLIMPSE**

#### "Eigenbot" - Modular Robot for Rapid Prototyping

Pioneering distributed neural control on a custom modular robotic platform bioinspired by insect neural networks. System article for publication at IROS.

#### "Twin Turbo Multiphase Board" - Reference Design

Designed, assembled, and tested TI's stackable Buck Power IC up to 6 phases. Competed with industry standards of efficiency, load transient, and EMI.

#### "Micromouse" - Embedded Maze Solving Robot

Built from scratch robot with IR Sensors, wheel encoders; implemented PID and Floodfill in C. 1st Place Rookies (UCLA 2019), 3rd Place (UCSD 2019)

#### **PUBLICATIONS**

[1] H. Kou and P. Shalton, "EVM User's Guide: TPSM64406EVM TPSM64406EVM 36-V, Dual, 3-A Output, Synchronous, Buck Module," Texas Instruments, Nov. 2023. Available: <a href="https://www.ti.com/lit/ug/slvuct0/slvuct0.pdf">https://www.ti.com/lit/ug/slvuct0/slvuct0.pdf</a>

[2] E. Lee and H. Kou, "User's Guide LMQ644A2-Q1 6-Phase Buck Regulator Design for Automotive ADAS Applications," Texas Instruments, Jul. 2023. Available: <a href="https://www.ti.com/lit/pdf/snvaa32">https://www.ti.com/lit/pdf/snvaa32</a>

[3] H. Kou and J. Hua, "User's Guide LMR54450-Q1 36-V, 5-A Buck Converter Evaluation Module," Texas Instruments, Jun. 2022. Available: https://www.ti.com/lit/pdf/slyucfQ

[4] M. Davis-Marsh and H. Kou, "TPSM64404/06 3-V to 36-V, Low IQ, Dual 2/3-A Module Optimized for Power Density and Low EMI," Texas Instruments, Dec. 2023. Available: <a href="https://www.ti.com/lit/gpn/TPSM64406">https://www.ti.com/lit/gpn/TPSM64406</a>

#### **Works in Progress**

Carnegie Mellon University Robotics Institute Publications (In progress)

[1] L. Li, J. Whitman, R. Wong, Z. Zhang, J. Subramanian, and H. Kou, "EigenBot: a Modular System for Rapid Robot Prototyping," Carnegie Mellon University Robotics Institute, 2023.

■ EigenBot:\_A\_Modular\_System\_for\_Rapid\_Robot\_Prototyping

[2] Z. Zhang, H. Kou, J. Ma, Y. Jin, L. Li, and H. Choset, "Distributed and Neural Bioinspired Control of Modular Hexapod Locomotion," 11292023Distributed and Neural Bioinspired Control of Modular Hexapod Locomotion.pdf

#### **AWARDS**

2021 - UCLA IDEAHacks 2nd Place: Gnome

2020 - UCLA IDEAHacks Honorary Mention: Salt-o-matic

2019 - California Micromouse Competition at UCSD Third Place: Team HITB

2019 - All American Micromouse Competition at UCLA First Place 1st Year: Team Orphans

2016 - Silicon Valley Regional Team 2035 FRC Chairman's Award

2014 - Silicon Valley Regional Team 2035 FRC Engineering Inspiration Award

#### PROJECT PORTFOLIO